

## ■ DESCRIPTION

The STP4407A is the P-Channel logic enhancement mode power field effect transistor is produced using high cell density advanced trench technology to provide excellent  $R_{DS(ON)}$ . This device is suitable for use as a load switch or in PWM and gate charge for most of the synchronous buck converter applications.

**STP4407AM-TRG ROHS Compliant This is Halogen Free**

-30V P-Channel Fast Switching MOSFETs

## ■ FEATURE

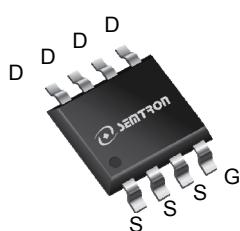
- ◆ -30V/-14A,  $R_{DS(ON)} = 8.2m\Omega$ (typ.)@ $V_{GS} = -20V$
- ◆ -30V/-12A,  $R_{DS(ON)} = 9.2m\Omega$ (typ.)@ $V_{GS} = -10V$
- ◆ -30V/-10A,  $R_{DS(ON)} = 10.8m\Omega$ (typ.)@ $V_{GS} = -6V$
- ◆ -30V/-7.0A,  $R_{DS(ON)} = 12.5m\Omega$ (typ.)@ $V_{GS} = -4.5V$
- ◆ Super high density cell design for extremely low  $R_{DS(ON)}$
- ◆ Exceptional on-resistance and Maximum DC current capability

## ■ APPLICATIONS

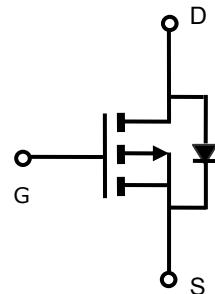
- ◆ Power Management in Note book
- ◆ High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/GA
- ◆ Networking DC-DC Power System
- ◆ Load Switch



## ■ PIN CONFIGURATION



SOP-8  
Top View



## ■ PART NUMBER INFORMATION

<b>STP 4407A M - TR G</b> a      b      c      d      e	a : Company name. b : Product Serial number. c : Package code d : Handling code e : Green produce code
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## ■ ORDERING INFORMATION

Part Number	Package Code	Handling Code	Shipping
STP4407AM-TRG	M : SOP-8	TR : Tape&Reel	2.5K/Reel

\* SOP-8 : Only available in tape and reel packaging.

## ■ ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ Unless otherwise noted)

Symbol	Parameter	Typical	Unit
$V_{DSS}$	Drain-Source Voltage	-30	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Continuous Drain Current, $V_{GS}=10\text{V}^A$	$T_A=25^\circ\text{C}$	-14
		$T_A=70^\circ\text{C}$	-10
$I_{DM}$	Pulsed Drain Current <sup>B</sup>	-50	A
$E_{AS}$	Single Pulse Avalanche energy L=0.1mH <sup>C</sup>	100	mJ
$P_D$	Power Dissipation	$T_A=25^\circ\text{C}$	3.1
		$T_A=70^\circ\text{C}$	2.0
$T_J$	Operation Junction Temperature	-55/150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55/150	$^\circ\text{C}$

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

## ■ THERMAL DATA

Symbol	Parameter	Min	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient			40	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance-Junction to Case			24	$^\circ\text{C/W}$

**ELECTRICAL CHARACTERISTICS( $T_A = 25^\circ C$  Unless otherwise noted )**

Symbol	Parameter	Condition	Min	Typ	Max	Unit	
<b>Static Parameters</b>							
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-30			V	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1.0		-2.0	V	
$I_{GSS}$	Gate Leakage Current	$V_{DS}=0V, V_{GS}=\pm 20V$			$\pm 100$	nA	
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=-24V, V_{GS}=0V$			-1	$\mu A$	
		$V_{DS}=-24V, V_{GS}=0V$ $T_J=55^\circ C$			-5		
$R_{DS(ON)}$	Drain-source On-Resistance <sup>B</sup>	$V_{GS}=-20V, I_D=-14A$		8.2	10	$m\Omega$	
		$V_{GS}=-10V, I_D=-12A$		9.2	12		
		$V_{GS}=-6.0V, I_D=-10A$		10.8	13		
		$V_{GS}=-4.5V, I_D=-7A$		12.5	15		
$R_g$	Gate resistance	$V_{DS}=V_{GS}=0V, f=1MHz$		2		$\Omega$	
<b>Source-Drain Diode</b>							
$V_{SD}$	Diode Forward Voltage	$I_S=-2.0A, V_{GS}=0V$		-0.7	-1.2	V	
$I_S$	Continuous Source Current <sup>AD</sup>				-14	A	
<b>Dynamic Parameters</b>							
$Q_g$	Total Gate Charge	$V_{DS}=-15V, V_{GS}=-4.5V$ $I_D=-14A$		30		nC	
$Q_{gs}$	Gate-Source Charge			4.4			
$Q_{gd}$	Gate-Drain Charge			10.2			
$C_{iss}$	Input Capacitance	$V_{DS}=-15V, V_{GS}=0V$ $f=1MHz$		1580		pF	
$C_{oss}$	Output Capacitance			321			
$C_{rss}$	Reverse Transfer Capacitance			250			
$t_{d(on)}$	Turn-On Time	$V_{DD}=-15V, V_{GS}=-10V,$ $I_D=-1A, R_G=6\Omega$		13.2		nS	
$t_r$				15			
$t_{d(off)}$	Turn-Off Time			52			
$t_f$				30			

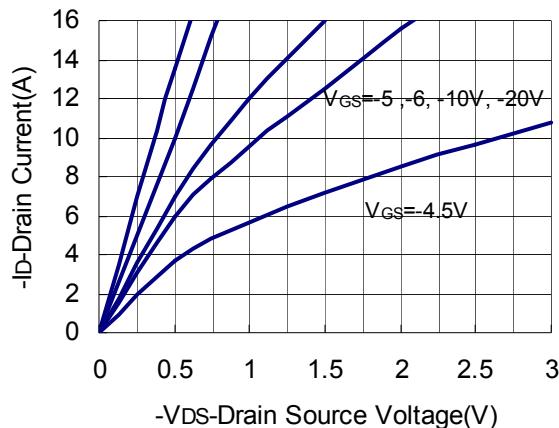
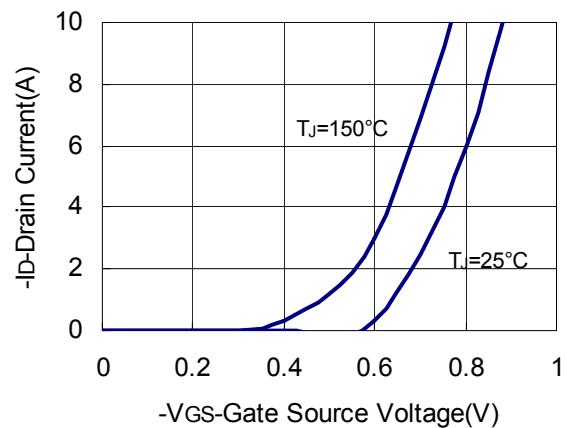
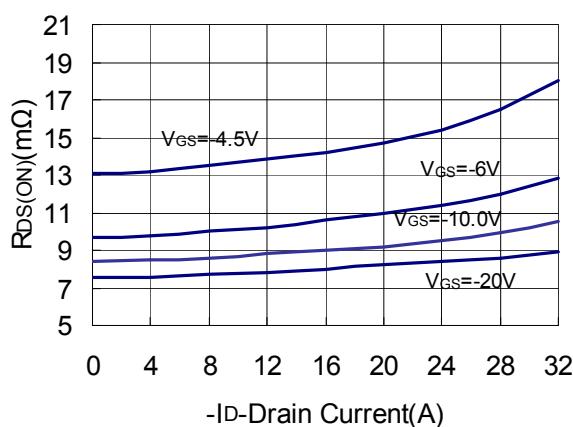
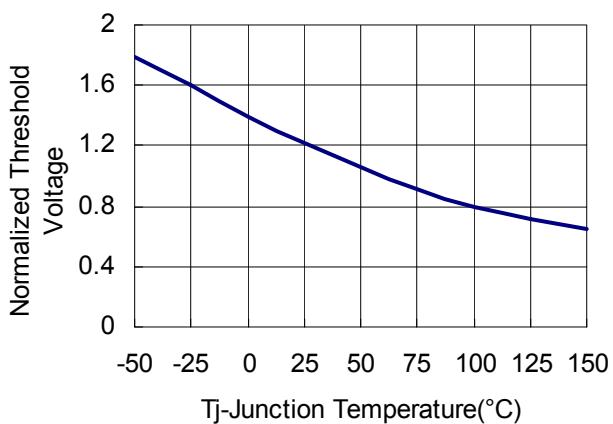
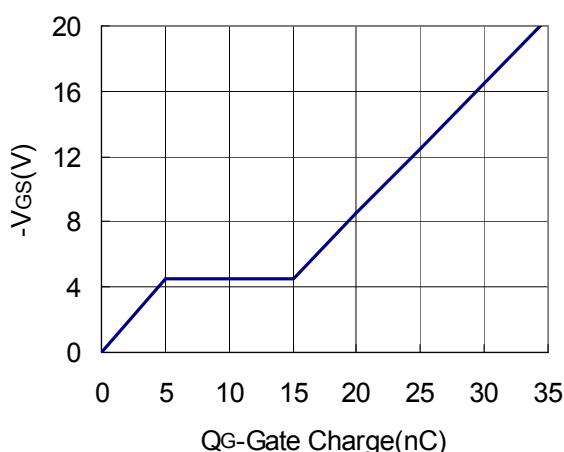
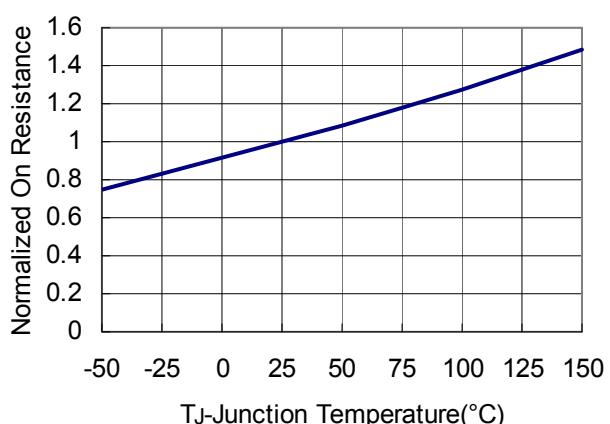
Note:

- A. The value of  $R_{DS(on)}$  is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ C$ .
- B. The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$
- C. The EAS data shows Max. rating . The test condition is  $V_{DD}=-25V, V_{GS}=-10V, L=0.1mH$ .
- D. The data is theoretically the same as  $I_D$  and  $I_{DM}$  , in real applications , should be limited by total power dissipation.

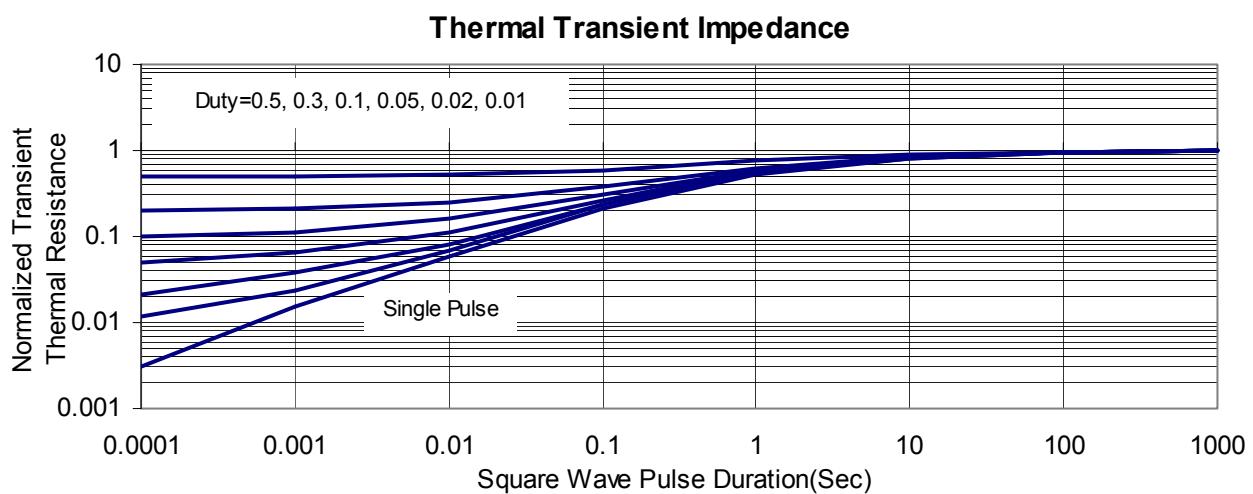
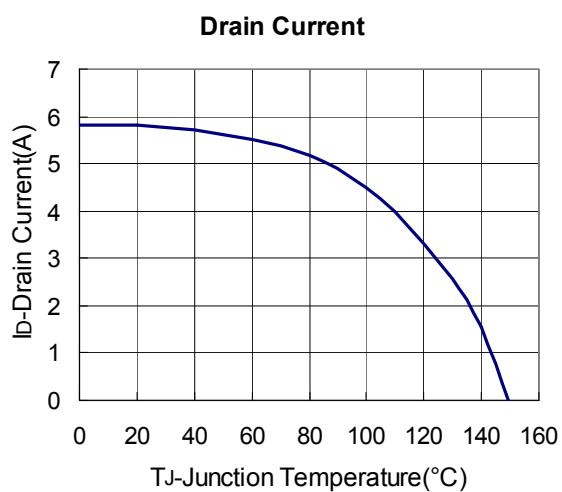
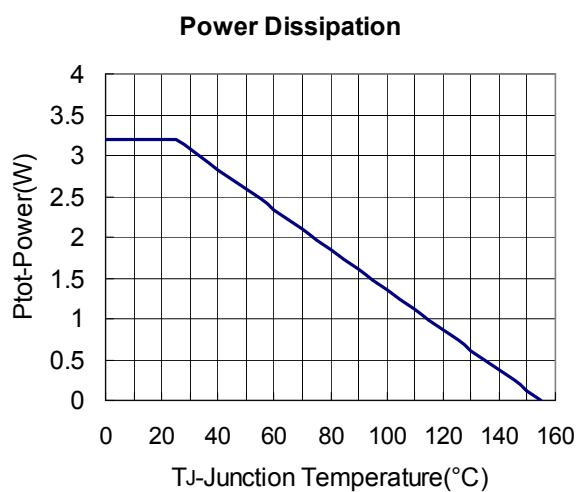
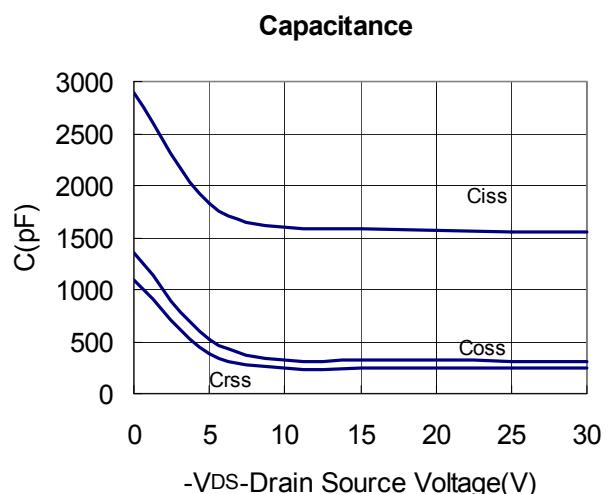
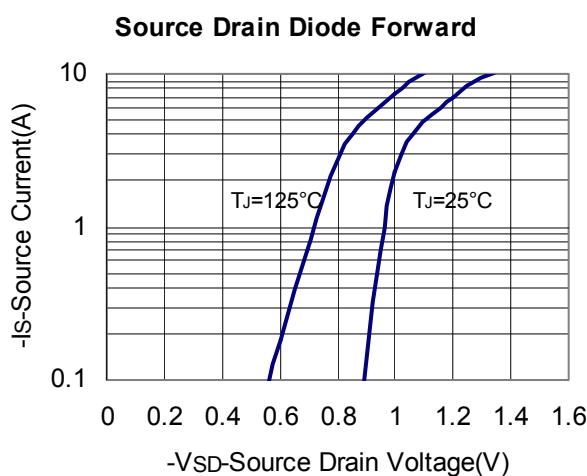
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## ■ TYPICAL CHARACTERISTICS

**Output Characteristics**

**Transfer Characteristics**

**Drain Source On Resistance**

**Gate Threshold Voltage**

**Gate Charge**

**Drain Source On Resistance**


## ■ TYPICAL CHARACTERISTICS



**SOP-8 PACKAGE DIMENSIONS**

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.040	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 BSC		0.050 BSC	
L	0.400	1.270	0.016	0.050
$\theta$	$0^\circ$	$8^\circ$	$0^\circ$	$8^\circ$

